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LTC5507

100kHz to 1GHz RF Power Detector

FEATURES

- Temperature Compensated Internal Schottky Diode RF Detector
- Wide Input Power Range: –34dBm to 14dBm
- Ultra Wide Input Frequency Range: 100kHz to 1000MHz
- Buffered Output
- Wide V_{CC} Range of 2.7V to 6V
- Low Operating Current: 550µA
- Low Shutdown Current: <2µA</p>
- Low Profile (1mm) ThinSOT[™] Package

APPLICATIONS

- Wireless Transceivers
- Wireless and Cable Infrastructure
- RF Power Alarm
- Envelope Detector

DESCRIPTION

The LTC[®]5507 is an RF power detector for applications operating from 100kHz to 1000MHz. The input frequency range is determined by an external capacitor. A temperature-compensated Schottky diode peak detector and buffer amplifier are combined in a small 6-pin ThinSOT package.

The RF input voltage is peak detected using an on-chip Schottky diode and external capacitor. The detected voltage is buffered and supplied to the V_{OUT} pin. A power saving shutdown mode reduces supply current to less than 2μ A.

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TYPICAL APPLICATION

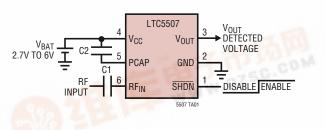
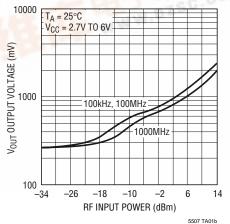


Figure 1. 100kHz to 1000MHz RF Power Detector

Typical Detector Characteristics at 100kHz. 100MHz and 1000MHz



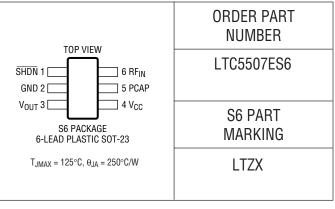
LTC5507

ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{CC}, V_{OUT} to GND	
SHDN Voltage to GND	
PCAP Voltage to GND (V _{CC} - 1.8	
I _{VOUT}	5mA
Operating Temperature Range (Note 2) – 40°C	
Maximum Junction Temperature	125°C
Storage Temperature Range – 65°C t	to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 3.6V, RF Input Signal is Off, unless otherwise noted.

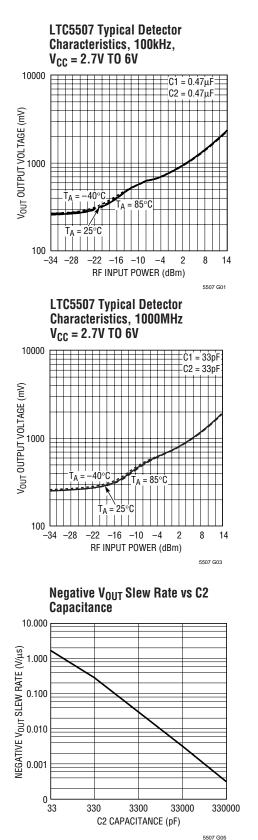
PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V _{CC} Operating Voltage			2.7		6	V
I _{VCC} Shutdown Current	SHDN = 0V				2	μA
I _{VCC} Operating Current	$\overline{\text{SHDN}} = V_{CC}, I_{VOUT} = 0 \text{mA}$			0.55	0.85	mA
V _{OUT} V _{OL} (No RF Input)	$\frac{R_{LOAD}}{SHDN} = 2k$, $\overline{SHDN} = V_{CC}$, Enabled $\overline{SHDN} = 0V$, Disabled		130	250 1	370	mV mV
V _{OUT} Output Current	$V_{OUT} = 1.75V, V_{CC} = 2.7V \text{ to } 6V, \Delta V_{OUT} = 10mV$		1	2		mA
V _{OUT} Enable Time	$\overline{\text{SHDN}} = V_{\text{CC}}, C_{\text{LOAD}} = 33 \text{pF}, R_{\text{LOAD}} = 2 \text{k}$			7	20	μs
V _{OUT} Load Capacitance	(Note 4)				33	pF
V _{OUT} Noise	V_{CC} = 3V, Noise BW = 1.5MHz, 50 Ω RF Input Termination			2		mV _{P-P}
SHDN Voltage, Chip Disabled	V _{CC} = 2.7V to 6V				0.35	V
SHDN Voltage, Chip Enabled	V _{CC} = 2.7V to 6V		1.4			V
SHDN Input Current	<u>SHDN</u> = 3.6V			24	40	μA
RF _{IN} Input Frequency Range			0.1-1000		MHz	
Max RF _{IN} Input Power	(Note 3)		14		dBm	
RF _{IN} AC Input Resistance	F = 10MHz, RF Input = -10dBm F = 1000MHz, RF Input = -10dBm		130 95		Ω Ω	
RF _{IN} Input Shunt Capacitance		1.7		pF		

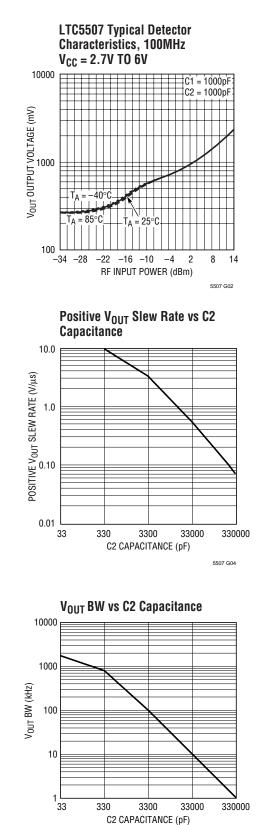
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: RF performance is tested at: 80MHz, -4dBm Note 4: Guaranteed by design.

TYPICAL PERFORMANCE CHARACTERISTICS





LTC5507

PIN FUNCTIONS

SHDN (Pin 1): Shutdown Input. A logic low or no-connect on the SHDN pin places the part in shutdown mode. A logic high enables the part. SHDN has an internal 150k pull down resistor to ensure that the part is in shutdown when the enable driver is in a tri-state condition.

GND (Pin 2): System Ground.

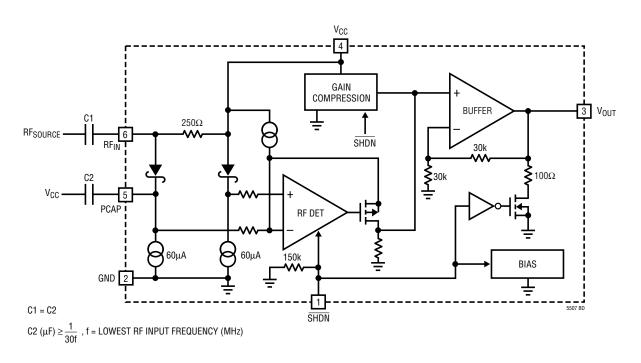
V_{OUT} (**Pin 3**): Buffered and Level Shifted Detector Output Voltage.

 V_{CC} (Pin 4): Power Supply Voltage, 2.7V to 6V. V_{CC} should be bypassed with 0.1 μ F and 100pF ceramic capacitors.

PCAP (Pin 5): Peak Detector Hold Capacitor. Capacitor value is dependent on RF frequency. Capacitor must be connected between PCAP and V_{CC} .

 $\mathbf{RF_{IN}}$ (Pin 6): RF Input Voltage. Referenced to V_{CC}. A coupling capacitor must be used to connect to the RF signal source. This pin has an internal 250 Ω termination and an internal Schottky diode detector.

BLOCK DIAGRAM





APPLICATIONS INFORMATION

Operation

The LTC5507 integrates several functions to provide RF power detection over frequencies up to 1000MHz. These functions include an internally compensated buffer amplifier, an RF Schottky diode peak detector and level shift amplifier to convert the RF signal to DC, a delay circuit to avoid voltage transients at V_{OUT} when coming out of shutdown, and a gain compression circuit to extend the detector dynamic range.

Buffer Amplifier

The buffer amplifier has a gain of two and is capable of driving a 2mA load. The buffer amplifier typically has an output voltage range of 0.25V to $V_{CC} - 0.1V$.

RF Detector

The internal RF Schottky diode peak detector and level shift amplifier converts the RF input signal to a low frequency signal. The frequency range of the RF pin is typically up to 1000MHz. The detector demonstrates excellent operation over a wide range of input power. The Schottky detector is biased at about 70μ A. The hold capacitor is external.

Gain Compression

The gain compression circuit changes the feedback ratio as the RF peak-detected input voltage increases above 60mV. Below 60mV, the DC voltage gain from the peak detector to the buffer output is 4. Above 140mV, the DC voltage gain is reduced to 0.75. The compression expands the low power detector range due to higher gain.

Modes of Operation

MODE	SHDN	OPERATION
Shutdown	Low	Disabled
Enable	High	Power Detect

Applications

The LTC5507 can be used as a self-standing signal strength measuring receiver for a wide range of input signals from -34dBm to 14dBm for frequencies up to 1000MHz.

The LTC5507 can be used as a demodulator for AM and ASK modulated signals with data rates up to 1.5MHz. Depending on specific application needs, the RSSI output can be split into two branches, providing AC-coupled data (or audio) output and DC-coupled, RSSI output for signal strength measurements and AGC.

C1, C2 Capacitor Selection (Refer to Figure 3)

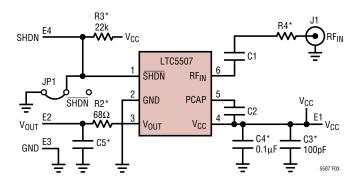
C1 couples the RF input signal to the detector input RF_{IN} which is referenced to V_{CC} . C2 is the peak detector capacitor connected between PCAP and V_{CC} . The value of C2 will affect the slew rate and bandwidth. Typically C1 can equal C2. Ceramic capacitors are recommended for C1 and C2. The values for C1 and C2 are dependent on the operating RF frequency. The capacitive reactance should be less than 5 Ω to minimize ripple on C2.

 $C2(\mu F) \geq 1/(30 \bullet f)$ where f is the lowest RF input frequency (MHz)

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C1 = C2
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In general, select C1 and C2 large enough to pass the lowest expected RF signal frequency, as described by the above formulas. But optimize C1 and C2, subject to this constraint, to improve output slew rate and bandwidth, and to enable good AC performance for the highest expected RF signal frequency.

APPLICATIONS INFORMATION



* OPTIONAL COMPONENTS R2 AND C5 FORM AN OPTIONAL OUTPUT LOWPASS FILTER.

R3 IS USED FOR DEMO PURPOSES ONLY, AND IS NOT USED IN ACTUAL PRODUCT IMPLEMENTATION. R4 CAN BE USED FOR INPUT POWER LIMITING OR BROADBAND IMPEDANCE MATCHING.

C3 AND C4 ARE OPTIONAL POWER SUPPLY FILTERS.

Figure 3. Evaluation Demo Board Schematic

PACKAGE DESCRIPTION

2.90 BSC 0.95 REF 0.62 (NOTE 4) MAX 1.22 REF 1.50 – 1.75 2.80 BSC 3.85 MAX 2.62 REF 1.4 MIN (NOTE 4) PIN ONE ID RECOMMENDED SOLDER PAD LAYOUT PER IPC CALCULATOR 0.30 - 0.45 6 PLCS (NOTE 3) 0.95 BSC -0.80 - 0.900.20 BSC 0.01 - 0.10 1.00[']MAX DATUM 'A' - 0.30 - 0.50 REF - 1.90 BSC 0.09 - 0.20 (NOTE 3) (NOTE 3) 1. DIMENSIONS ARE IN MILLIMETERS 2. DRAWING NOT TO SCALE 3. DIMENSIONS ARE INCLUSIVE OF PLATING 4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR 5. MOLD FLASH SHALL NOT EXCEED 0.254mm 6. IEDEC PACKAGE DEEEPENCE IS MOLD 102 S6 TS0T-23 0302

S6 Package 6-Lead Plastic TSOT-23 (Reference LTC DWG # 05-08-1636)

6. JEDEC PACKAGE REFERENCE IS MO-193

LTC5507

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS			
RF Power Controllers					
LTC1757A	RF Power Controller	Multiband GSM/DCS/GPRS Mobile Phones			
LTC1758	RF Power Controller	Multiband GSM/DCS/GPRS Mobile Phones			
LTC1957	RF Power Controller	Multiband GSM/DCS/GPRS Mobile Phones			
LTC4400	ThinSOT RF PA Controller	Multiband GSM/DCS/GPRS Phones, 45dB Dynamic Range, 450kHz Loop BW			
LTC4401	ThinSOT RF PA Controller	Multiband GSM/DCS/GPRS Phones, 45dB Dynamic Range, 250kHz Loop BW			
LTC4403	Multiband RF Power Controllers for EDGE/TDMA	Supports EDGE/TDMA Applications			
LT5504	800MHz to 2.7GHz RF Measuring Receivers	80dB Dynamic Range, Temperature Compensated, 2.7V to 5.5V Supply			
LTC5505	300MHz to 3.5GHz RF Power Detector	>40dB Dynamic Range, Temperature Compensated, 2.7V to 6V Supply			
LTC5508	300MHz to 7GHz RF Power Detector	>40dB Dynamic Range, SC-70 Package			
Other Related P	arts				
LT5500	1.8GHz to 2.7GHz, Receiver Front End	Dual LNA gain Setting +13.5dB/–14dB at 2.5GHz, Double-Balanced Mixer, 1.8V to 5.25V Supply			
LT5502	400MHz Quadrature Demodulator with RSSI	1.8V to 5.25V Supply, 70MHz to 400MHz IF, 84dB Limiting Gain, 90dB RSSI Range			
LT5503	1.2GHz to 2.7GHz Direct IQ Modulator and Up Converting Mixer	1.8V to 5.25V Supply, Four-Step RF Power Control, 120MHz Modulation Bandwidth			
LT5506	500MHz Quadrature IF Demodulator with VGA	1.8V to 5.25V Supply, 40MHz to 500MHz IF, –4dB to 57dB Linear Power Gain			
LT5511	High Signal Level Upconverting Mixer	10MHz to 3000MHz RF Output Range, Integrated LO Buffer, 17dBm IIP3			
LT5512	High Signal Level Down Converting Mixer	DC-3GHz, 20dBm IIP3, Integrated LO Buffer			

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